Surface Mount Fuse Block NANO2® > 155 OMNI-BLOK®

155900 Series OMNI-BLOK® Fuseblock

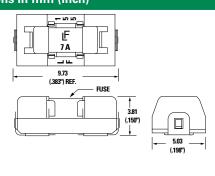


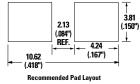


Agency Approvals

Agency	Agency File Number	Ampere Range
c FL ° us	E14721	10 A

Dimensions in mm (inch)





Description

The RoHS compliant 155 Series OMNI-BLOK® offers a solution for efficient installation and easy replacement of miniature Nano²® surface mount fuses. Offered bulk but also in a tape and reel package, this block can be installed on a PC board as an efficient single step. Fuse replacement can be accomplished without exposing the PC board to the detrimental effects of solder heat.

Features

- Easy fuse replacement
- Miniature size
- RoHS-compliant and Halogen-free
- Very Fast-Acting and Time-Lag options available
- Holder sized to fit a range of Nano^{2®} type fuses
- Suitable for applications up to 125 V and 10 A

- Wide operating temperature range
- Heat-resistant fuseholder, UL94 V-0
- 260 °C reflow capable fuseholder
- Recognized to UL/CSA/ NMX 4248-1

Additional Information







Resources

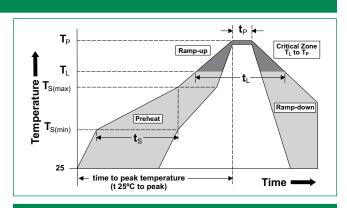
Samples

Packaging

Part Number	Packaging Specification	Quantity	Packaging Option
01550900DR	EIA-481, IEC 60286-3	1500	Tape and Reel
01550900M	EIA-481, IEC 60286-3	1000	Bulk

Soldering Parameters

Reflow Condition		Pb-free assembly
Pre Heat	-Temperature Min (T _{s(min)})	150 °C
	-Temperature Max (T _{s(max)})	200 °C
	-Time (Min to Max) (t _s)	60-180 seconds
Average Ran	5 °C/second max.	
T _{S(max)} to T _L - Ramp-up Rate		5 °C/second max.
Reflow	- Temperature (T _L) (Liquidus)	217 °C
	- Temperature (t _L)	60-150 seconds
Peak Temper	260+0/-5 °C	
Time within	20-40 seconds	
Ramp-down Rate		5 °C/second max.
Time 25 °C to peak Temperature (T _p)		8 minutes max.
Do not exceed		260 °C



Product Characteristics

Operating Temperature -55 °C to 125 °C